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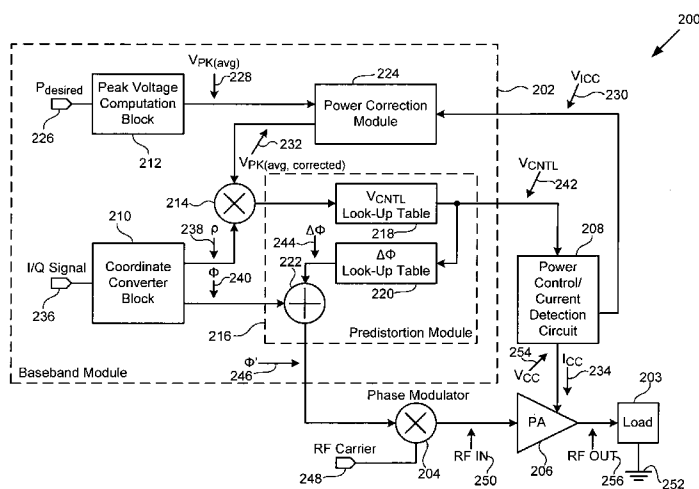
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(54) Title: OUTPUT POWER CORRECTION MODULE FOR AMPLIFIERS IN TRANSMITTERS



(57) Abstract: According to an exemplary embodiment, a transmitter system (200) includes a power amplifier (206) receiving a supply voltage (254) and a supply current (234) from a power control/current detection circuit (208), where the power amplifier (206) drives a load impedance. The transmitter system (200) further includes a power correction module (224) configured to sample the supply current and to cause a change in a control voltage (242), which corrects the supply voltage (254) in response to a change in the load impedance. The supply voltage (254) is corrected to cause the power amplifier (206) to have a substantially constant output power. The power correction module (224) is further configured to output a corrected peak voltage (232) determined by an average value of the supply current (234). The transmitter system (200) further includes a predisortion module (216) configured to determine the control voltage (242) from a product of the corrected peak voltage (232) and an amplitude modulation component (238) and to output the control voltage (242) to the power control/current detection circuit (208).

OUTPUT POWER CORRECTION MODULE FOR AMPLIFIERS IN TRANSMITTERS

BACKGROUND OF THE INVENTION

5 The present application claims the benefit of and priority to a pending provisional patent application entitled "Power Correction Module for Power Amplifiers," Serial Number 60/850,324 filed on October 6, 2006. The disclosure in that pending provisional application is hereby incorporated fully by reference into the present application.

10 1. FIELD OF THE INVENTION

 The present invention relates to the field of electrical circuits. More particularly, the invention relates to amplifier circuits.

2. BACKGROUND ART

 Power amplifiers, such as saturated power amplifiers, used in communications
15 devices, such as mobile telephones, are required to operate under wide variations in load impedance. Under these variations in load impedance, it is highly desirable for power amplifiers, such as saturated power amplifiers, to maintain a constant output power. It is also highly desirable for power amplifiers in transmitter systems utilizing predistortion for complex data modulations, such as data modulations utilized in the
20 Enhanced Data Rates for GSM Evolution (EDGE) communications standard, to maintain a constant output power under load impedance variations. As a result, various techniques have been employed in an attempt to control the output power of a power amplifier.

 However, conventional techniques for controlling the output power of a power
25 amplifier suffer various disadvantages. For example, techniques that indirectly control the output power by controlling the voltage or current, such as collector voltage or collector current, supplied to the power amplifier provide adequate compensation for variations in operating conditions, such as variations in temperature and supply voltage, but undesirably allow significant variations in power delivered to a varying
30 load. For example, in the voltage or current control techniques discussed above, the

power delivered to the load by the power amplifier can vary by as much as 10.0 decibels (dB) as the impedance of the load changes.

In another conventional approach, a constant DC power is delivered to a power amplifier, such as a saturated power amplifier, by utilizing a feedback loop to adjust the collector voltage of the power amplifier. Since the power amplifier output power is equal to the product of the DC power and the collector efficiency, this approach can provide a constant output power if constant collector efficiency is maintained.

However, this approach presents significant problems in transmitter systems utilizing predistortion, such as transmitter systems utilizing polar EDGE modulation.

SUMMARY OF THE INVENTION

An output power correction module for amplifiers in transmitters, substantially as shown in and/or described in connection with at least one of the figures, as set forth more completely in the claims.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a block diagram of an exemplary conventional transmitter system.

Figure 2 is a block diagram of an exemplary transmitter system including an exemplary power correction module in accordance with one embodiment of the
5 present invention.

Figure 3 is a block diagram of an exemplary power correction module in accordance with one embodiment of the present invention.

Figure 4 illustrates a circuit diagram of an exemplary power control/current detection circuit in accordance with one embodiment of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

The present invention is directed to an output power correction module for amplifiers in transmitters. The following description contains specific information pertaining to the implementation of the present invention. One skilled in the art will recognize that the present invention may be implemented in a manner different from that specifically discussed in the present application. Moreover, some of the specific details of the invention are not discussed in order not to obscure the invention. The specific details not described in the present application are within the knowledge of a person of ordinary skill in the art.

The drawings in the present application and their accompanying detailed description are directed to merely exemplary embodiments of the invention. To maintain brevity, other embodiments of the invention which use the principles of the present invention are not specifically described in the present application and are not specifically illustrated by the present drawings.

The present invention provides an innovative power correction module for correcting output power of a power amplifier in a transmitter system under variations in load impedance. Although a transmitter system utilizing polar modulation, such as polar EDGE modulation - which requires predistortion and provides both phase and amplitude modulation - is utilized to illustrate the present invention, the present invention can also be applied in a transmitter system in which amplitude modulation or predistortion are not utilized.

Figure 1 shows a block diagram of an exemplary conventional transmitter system coupled to a load. Certain details and features have been left out of Figure 1, which are apparent to a person of ordinary skill in the art. Conventional transmitter system 100, which is coupled to load 103, includes baseband module 102, phase modulator 104, power amplifier 106, and power control circuit 108. Baseband module 102 includes coordinate converter block 110, peak voltage computation block 112, multiplication element 114, and predistortion module 116, which includes control voltage (V_{CNTL}) look-up table 118, phase shift ($\Delta\Phi$) look-up table 120, and summation element 122. Conventional transmitter system 100 can be utilized in a wireless

communications device, such as a mobile telephone, that can utilize a communications standard, such as an EDGE communications standard. Conventional transmitter system 100 can also utilize polar modulation, such as polar EDGE modulation, which utilizes predistortion.

5 As shown in Figure 1, desired average output power (P_{desired}) 124, which is a desired average output power of power amplifier 106, is coupled to the input of peak voltage computation block 112 and the output of peak voltage computation block 112 is coupled to an input of multiplication element 114. Peak voltage computation block 112 can be configured to receive P_{desired} 124, compute a corresponding average peak
 10 voltage ($V_{\text{PK(avg)}}$) corresponding to P_{desired} 124, and output $V_{\text{PK(avg)}}$ (indicated by arrow 126) to multiplication element 114. Also shown in Figure 1, I/Q signal 128, which can be utilized to provide amplitude and phase modulation information, is coupled to the input of coordinate converter block 110 and the respective outputs of coordinate converter block 110 are coupled to inputs of multiplication element 114 and
 15 summation element 122. Coordinate converter block 110 can be configured to receive I/Q signal 128, convert I/Q signal 128 from Cartesian coordinates (I, Q) to polar coordinates (ρ , Φ), where “ ρ ” is an ideal amplitude modulation component and “ Φ ” is an ideal phase modulation component, to filter the resulting signal, and to output ρ (indicated by arrow 130) and Φ (indicated by arrow 132) to respective inputs of
 20 multiplication element 114 and summation element 122. The conversion from Cartesian coordinates (I, Q) to polar coordinates (ρ , Φ) can be performed by, for example, a baseband processor, which is not shown in Figure 1.

Further shown in Figure 1, the output of multiplication element 114 is coupled to the input of V_{CNTL} look-up table 118 and the output of V_{CNTL} look-up table 118 is
 25 coupled to the inputs of $\Delta\Phi$ look-up table 120 and power control circuit 108. Multiplication element 114 can be configured to receive $V_{\text{PK(avg)}}$ and ρ , form the product of ρ and $V_{\text{PK(avg)}}$ ($\rho \bullet V_{\text{PK(avg)}}$), and to output $\rho \bullet V_{\text{PK(avg)}}$ to V_{CNTL} look-up table 118. V_{CNTL} look-up table 118 can be configured to receive the product of $\rho \bullet V_{\text{PK(avg)}}$ and to determine a corresponding predistorted control voltage (V_{CNTL}), and to
 30 output V_{CNTL} (indicated by arrow 132) to $\Delta\Phi$ look-up table 120 and power control

circuit 108. Also shown in Figure 1, the output of $\Delta\Phi$ look-up table 120 is coupled to an input of summation element 122 and the output of summation element 122 is coupled to an input of phase modulator 104. $\Delta\Phi$ look-up table 120 can be configured to receive V_{CNTL} from V_{CNTL} look-up table 118, utilize V_{CNTL} to determine an appropriate amount of phase shift ($\Delta\Phi$) corresponding to V_{CNTL} to apply to the ideal phase modulation component, i.e., Φ , and to output $\Delta\Phi$ (indicated by arrow 134) to an input of summation element 122. V_{CNTL} look-up table 118 and $\Delta\Phi$ look-up table 120 can be formed during a calibration procedure for a communications device, such as a mobile telephone, in which transmitter system 100 resides.

Summation element 122 can be configured to form the sum of $\Delta\Phi$ and Φ to form a predistorted phase modulation component (Φ'), and to output Φ' (indicated by arrow 136) to an input of phase modulator 104. Further shown in Figure 1, RF carrier 138 is coupled to an input of phase modulator 104 and the output of phase modulator 104 is coupled to the signal input of power amplifier 106. Phase modulator 104 can be a polar modulator, such as an EDGE polar modulator, and can be configured to modulate RF carrier 138 with Φ' and to output a phase modulated RF signal, i.e., RF IN 140, which is coupled to the signal input of power amplifier 106. Also shown in Figure 1, the output of power control circuit 108 is coupled to a supply voltage input, i.e., a collector voltage input, of power amplifier 106 and load 103 is coupled between the output of power amplifier 106 and ground 142. Power control circuit 108 can be configured to receive V_{CNTL} , i.e., a predistorted control voltage, from V_{CNTL} look-up table 118 in predistortion module 116 and to provide a collector current (I_{CC}) (indicated by arrow 144) and a collector voltage (V_{CC}) (indicated by arrow 146), to power amplifier 106. Power control circuit 108 can include a linear regulator (not shown in Figure 1) such that V_{CC} is linearly related to V_{CNTL} .

Power amplifier 106 can be a saturated power amplifier and can be configured to receive RF IN 140, which is a phase-modulated RF signal provided by phase modulator 104, to combine the predistorted phase and amplitude modulation components at the collector of power amplifier 106, and to output an RF signal, i.e., RF OUT 148, having accurate phase and amplitude modulation. Load 103, which can

be, for example, an antenna, can provide a load impedance between the output of power amplifier 106 and ground 142. The load impedance provided by load 103 can be designed to be, for example, 50.0 ohms. However, under adverse voltage standing wave ratio (VSWR) conditions, the load impedance presented to power amplifier 106 by load 103 can vary significantly from an ideal designed load impedance, such as a 50.0 ohm load impedance. When the load impedance presented to power amplifier 106 varies, the output power provided by power amplifier 106 also varies. However, V_{CNTL} , which determines V_{CC} , is not corrected for a change in the load impedance. Thus, conventional transmitter system 100 does not provide correction for variations in load impedance. Therefore, the output power provided by power amplifier 106 in conventional transmitter system 100 can vary during variations in the load impedance of load 103.

Figure 2 shows a block diagram of an exemplary transmitter system coupled to a load in accordance with one embodiment of the present invention. Certain details and features have been left out of Figure 2, which are apparent to a person of ordinary skill in the art. Transmitter system 200, which is coupled to load 203, includes baseband module 202, phase modulator 204, power amplifier 206, and power control/current detection circuit 208. Baseband module 202 includes coordinate converter block 210, peak voltage computation block 212, multiplication element 214, power correction module 224, and predistortion module 216, which includes control voltage (V_{CNTL}) look-up table 218, phase shift ($\Delta\Phi$) look-up table 220, and summation element 222. Transmitter system 200 can be utilized in communications devices, such as mobile telephones, that utilize an EDGE communications standard or other suitable communications standards. Transmitter system 200 can utilize, for example, open-loop polar EDGE modulation, which utilizes predistortion. However, transmitter system 200 can also utilize other types of polar modulation.

As shown in Figure 2, desired average output power (P_{desired}) 226, which is a desired output power of power amplifier 206, is coupled to the input of peak voltage computation block 212 and the output of peak voltage computation block 212 is coupled to an input of power control module 224. Peak voltage computation block

212 can be configured to receive P_{desired} 226, to compute an average peak voltage ($V_{\text{PK(avg)}}$) corresponding to P_{desired} 226, and to output $V_{\text{PK(avg)}}$ (indicated by arrow 228) to an input of power correction module 224. Also shown in Figure 2, an output of power control/current detection circuit 208 is coupled to an input of power correction module 224 and the output of power correction module 224 is coupled to an input of multiplication element 214. Power correction module 224 can be configured to receive $V_{\text{PK(avg)}}$ from peak voltage computation block 212 and V_{ICC} (indicated by arrow 230) from power control/current detection circuit 208, to determine a corrected average peak voltage ($V_{\text{PK(avg, corrected)}}$) by adjusting $V_{\text{PK(avg)}}$ by a correction factor (k), and to output $V_{\text{PK(avg, corrected)}}$ (indicated by arrow 232).

The correction factor, i.e., k , can be determined from the equation:

$$k = \sqrt{\frac{I_{\text{CC(ideal)}}}{I_{\text{CC(measured)}}}} \quad \text{equation (1)}$$

where “ $I_{\text{CC(ideal)}}$ ” is the ideal collector current that power amplifier 206 should draw from power control/current detection circuit 208 for a desired average peak voltage, i.e., $V_{\text{PK(avg)}}$, corresponding to the desired output power, i.e., P_{desired} 226, of power amplifier 206, and where “ $I_{\text{CC(measured)}}$ ” is a measured average value of the collector current, i.e., I_{CC} (indicated by arrow 234), drawn by power amplifier 206. $I_{\text{CC(measured)}}$ can be determined from V_{ICC} , which is a feedback voltage that is substantially proportional to I_{CC} , i.e., the actual collector current drawn by amplifier 206. Thus, by receiving V_{ICC} , power correction module is sampling I_{CC} . An embodiment of the invention’s power correction module is further discussed below in relation to Figure 3.

Further shown in Figure 2, I/Q signal 236 is coupled to the input of coordinate converter block 210 and the respective outputs of coordinate converter block 210 are coupled to multiplication element 214 and summation element 222. I/Q signal 236 can be utilized to provide phase and amplitude modulation information. Coordinate converter block 210 can be configured to receive I/Q signal 236, convert I/Q signal 236 from Cartesian coordinates (I, Q) to polar coordinates (ρ, Φ), where “ ρ ” is an ideal amplitude modulation component and “ Φ ” is an ideal phase modulation component, to filter the signal, and to provide ρ (indicated by arrow 238) at one output and to output

Φ (indicated by arrow 240) at the other output. The conversion from Cartesian coordinates (I, Q) to polar coordinates (ρ , Φ) can be performed by, for example, a baseband processor (not shown in Figure 2) in baseband module 202.

Further shown in Figure 2, the output of multiplication element 214 is coupled to the input of V_{CNTL} look-up table 218 and the output of V_{CNTL} look-up table 218 is coupled to the inputs of $\Delta\Phi$ look-up table 220 and power control/current detection module 208. Multiplication element 214 can be configured to receive $V_{\text{PK (avg, corrected)}}$ from power correction module 224 and ρ from coordinate converter block 210, to form the product of ρ and $V_{\text{PK (avg, corrected)}}$ ($\rho \bullet V_{\text{PK (avg, corrected)}}$), and to output $\rho \bullet V_{\text{PK (avg, corrected)}}$ to the input of V_{CNTL} look-up table 218. V_{CNTL} look-up table 218 can be configured to receive $\rho \bullet V_{\text{PK (avg, corrected)}}$ from multiplication element 214, to determine a control voltage (V_{CNTL}) corresponding to $\rho \bullet V_{\text{PK (avg, corrected)}}$ by utilizing an appropriate look-up table, and to output V_{CNTL} (indicated by arrow 242) to the inputs of $\Delta\Phi$ look-up table 220 and power control/current detection circuit 208.

Also shown in Figure 2, the output of $\Delta\Phi$ look-up table 220 is coupled to an input of summation element 222 and the output of summation element 222 is coupled to an input of phase modulator 204. $\Delta\Phi$ look-up table 220 can be configured to receive V_{CNTL} from V_{CNTL} look-up table 218, to determine an amount of phase shift ($\Delta\Phi$) to add to Φ , i.e., the ideal phase component, corresponding to V_{CNTL} by utilizing an appropriate look-up table, and to output $\Delta\Phi$ (indicated by arrow 244) to an input of summation element 222. The look-up tables in V_{CNTL} look-up table 218 and $\Delta\Phi$ look-up table 220 can be formed during a calibration procedure for a communications device, such as a mobile telephone, in which transmitter system 200 resides. Summation element 222 can be configured to receive Φ from coordinate converter block 210 and $\Delta\Phi$ from $\Delta\Phi$ look-up table 220, to add Φ and $\Delta\Phi$ to form Φ' , i.e., a predistorted phase modulation component, and to output Φ' (indicated by arrow 246) to an input of phase modulator 204.

Also shown in Figure 2, RF carrier 248 is coupled to an input of phase modulator 204 and the output of phase modulator 204 is coupled to the signal input of power amplifier 206. Phase modulator 204 can be, for example, a polar modulator,

such as an EDGE polar modulator, and can be configured to receive Φ' from summation element 222 and RF carrier 248, to phase modulate RF carrier 248 with Φ' , and to output a phase modulated RF signal (RF IN 250) to the signal input of power amplifier 206. Further shown in Figure 2, the output of power control/current
5 detection circuit 208 is coupled to a supply voltage input, i.e., a collector voltage input, of power amplifier 206 and load 203 is coupled between the output of power amplifier 206 and ground 252.

Power control/current detection circuit 208 can be configured to receive V_{CNTL} , which is a predistorted control voltage, from V_{CNTL} look-up table 218, to provide a
10 supply voltage (V_{CC}) (indicated by arrow 254) and a supply current (I_{CC}) (indicated by arrow 234) to power amplifier 206, and to provide V_{ICC} (indicated by arrow 230) to power correction module 224. In power control/current detection circuit 208, V_{ICC} is proportional to I_{CC} and V_{CC} is linearly proportional to V_{CNTL} . An exemplary power control/current detection circuit is further discussed below in relation to Figure 4.

15 Power amplifier 206 can be a saturated power amplifier and can be configured to receive RF IN 250, which is a phase-modulated RF signal, from phase modulator 204, and V_{CC} , which is a predistorted amplitude modulated supply voltage, from power control/current detection circuit 208, to combine the predistorted phase and amplitude components at the collector of the power amplifier, and to output an RF
20 signal, i.e., RF OUT 256, having accurate phase and amplitude modulation. Load 203, which can be, for example, an antenna, has a load impedance, which is provided between the output of power amplifier 206 and ground 252. The load impedance of load 203 can be designed to be, for example, approximately equal to 50.0 ohms. However, the load impedance of load 203 can also be designed to be different than
25 50.0 ohms.

The operation of transmitter system 200 will now be discussed. Under adverse VSWR conditions, the load impedance presented to power amplifier 206 by load 203 can significantly vary from a designed "ideal" load impedance, which can be, for example, approximately 50.0 ohms. As the load impedance changes, I_{CC} , i.e., the
30 supply current drawn by power amplifier 206, will also change. In the present

embodiment, V_{ICC} , which is proportional to I_{CC} , is provided by power control/current detection circuit 208 and coupled to power correction module 224 to provide a sample of I_{CC} . In power correction module 224, V_{ICC} can be integrated over a predetermined time period to determine an integrated value of V_{ICC} , which can be utilized to

5 determine an average value of I_{CC} , i.e. $I_{CC(\text{measured})}$. By utilizing a known ideal collector current for the desired average peak voltage, i.e., $V_{PK(\text{avg})}$, a correction factor (k) can be determined and utilized to adjust $V_{PK(\text{avg})}$ for the load impedance of load 203.

The corrected average peak voltage, i.e., $V_{PK(\text{avg, corrected})}$ can be output by power correction module 224, combined with the amplitude modulation component, i.e., ρ ,

10 and input into V_{CNTL} look-up table 218. V_{CNTL} look-up table 218 provides a corresponding control voltage, i.e., V_{CNTL} , which is predistorted to correct for nonlinearities between V_{CC} and the RF output voltage and is input into power control/current detection circuit 208. V_{CNTL} , which is amplitude modulated and corrected for load impedance, is utilized to determine V_{CC} , which is applied to power
15 amplifier 206. V_{CNTL} is also input into $\Delta\Phi$ look-up table 220 to determine an appropriate amount of phase ($\Delta\Phi$) to add to the ideal phase modulation component (Φ) to correct for excess phase that can be introduced by modulating the collector voltage.

After the phase is predistorted, it is modulated onto RF carrier 248 in phase modulator 204 to form RF IN 250, which is applied to the signal input of power amplifier 206.

20 The predistorted phase and amplitude modulation components are combined at the collector of power amplifier 206 to produce RF OUT 256, which is a linear output signal having accurate phase and amplitude modulation.

By correcting V_{CNTL} for variations in load impedance, V_{CC} , which is determined by V_{CNTL} is also corrected for load impedance variations. DC power (P_{DC}) is
25 substantially equal to $V_{CC} \bullet I_{CC}$ and output power (P_{RF}) is substantially equal to $P_{DC} \bullet \eta$, which is the collector efficiency of power amplifier 206. By providing substantially constant collector efficiency under variations in load impedance, the present invention can provide a substantially constant power amplifier output power under a varying load impedance.

30 Thus, by utilizing a feedback loop including power control/current detection

circuit 208, power correction module 224, multiplication element 214, and predistortion module 216 and by providing a substantially constant collector efficiency, an embodiment of the present invention can provide output power correction for variations in load impedance at the output of power amplifier 206 so as to provide a substantially constant power output. In contrast, conventional transmitter system 100 does not provide output power correction for changes in load impedance. As a result, the output power provided by power amplifier 106 in conventional transmitter system 100 can undesirably vary under variations in load impedance.

Also, since load impedance variations typically occur very slowly compared to the modulation bandwidth of transmitter system 200, the feedback control loop provided by the present invention for correcting output power for variations in load impedance can be a relatively slow control loop. As a result, polar modulation in transmitter system 200 can operate in an essentially open-loop condition. Thus, the present invention eliminates the need for high-speed circuitry in the feedback loop, thereby reducing manufacturing cost.

Additionally, since the present invention provides the baseband module, e.g., baseband module 202, with collector current information, over-current protection can be implemented in software, if desired.

Figure 3 shows a block diagram of an exemplary power correction module in accordance with one embodiment of the present invention. In Figure 3, power correction module 324 corresponds to power correction module 224 in transmitter system 200 in Figure 2. Also, $V_{PK(avg)}$ 328, V_{ICC} 330, and $V_{PK(avg, corrected)}$ 332 in Figure 3 correspond, respectively, to $V_{PK(avg)}$ (indicated by arrow 228), V_{ICC} (indicated by arrow 230), and $V_{PK(avg, corrected)}$ (indicated by arrow 232) in Figure 2. Power correction module 324 includes multiplication element 338, $V_{PK(avg)}$ Correction Factor Block 340 (hereinafter referred to simply as “correction factor block 340”), $I_{CC(ideal)}$ Look-Up Table 342, and integrator 344. Power correction module 324 can be configured to receive $V_{PK(avg)}$ 328, which is an average peak voltage that is desired at the output of power amplifier 206 in Figure 2, and V_{ICC} 330, which is a feedback voltage that is proportional to I_{CC} , to determine k , which is a correction factor for adjusting the

average peak voltage in response to a change in load impedance of load 203, and to output $V_{PK(avg, corrected)}$ 332, which is a corrected average peak voltage.

As shown in Figure 3, V_{ICC} 330 is coupled to the input of integrator 344 and the output of integrator 344 is coupled to an input of correction factor block 340.

- 5 Integrator 344 can be configured to receive V_{ICC} 330, which is a feedback voltage from power control/current detection circuit 208 that corresponds to a sample of the supply current (I_{CC}) drawn by power amplifier 206, integrate V_{ICC} 330 over a selected time period, to determine an average value of I_{CC} , i.e., $I_{CC(measured)}$, from the integrated value of V_{ICC} 330, and to output $I_{CC(measured)}$ (indicated by arrow 350). Also shown in
- 10 Figure 3, $V_{PK(avg)}$ 328 is coupled to the input of $I_{CC(ideal)}$ Look-Up Table 342, the output of $I_{CC(ideal)}$ Look-Up Table 342 is coupled to an input of correction factor block 340, and the output of correction factor block 340 is coupled to an input of multiplication element 338.

- $I_{CC(ideal)}$ Look-Up Table 342 can be configured to receive $V_{PK(avg)}$ 328, to
- 15 determine an ideal collector current, i.e., a collector current that would be drawn by power amplifier 206 under a specified load impedance, such as a 50.0 ohm load impedance, corresponding to $V_{PK(avg)}$ 328, and to output $I_{CC(ideal)}$ (indicated by arrow 348). $I_{CC(ideal)}$ can be determined from a look-up table that can be generated during a calibration procedure for a communications device, such as a mobile telephone, in
- 20 which transmitter system 200 resides. Correction factor block 340 can be configured to receive $I_{CC(measured)}$ and $I_{CC(ideal)}$, to determine k , a correction factor, from equation (1) discussed above, and to output k (indicated by arrow 346) to multiplication element 338.

- Further shown in Figure 3, $V_{PK(avg)}$ 328 is coupled to an input of multiplication
- 25 element 338 and $V_{PK(avg, corrected)}$ 332 is output by multiplication element 338. Multiplication element 338 can be configured to receive $V_{PK(avg)}$ 328 and k , to determine the product of k and $V_{PK(avg)}$ 328, and to output a corrected average peak voltage, i.e., $V_{PK(avg, corrected)}$ 332.

- Figure 4 shows a circuit diagram of an exemplary power control/current
- 30 detection circuit coupled to an exemplary power amplifier in accordance with one

embodiment of the present invention. In Figure 4, power amplifier 406, power control/current detection circuit 408, V_{ICC} 430, I_{CC} (indicated by arrow 434), V_{CNTL} 442, RF IN 450, V_{CC} (indicated by arrow 454) and RF OUT 456 correspond, respectively, to power amplifier 206, power control/current detection circuit 208, V_{ICC} (indicated by arrow 230), I_{CC} (indicated by arrow 234), V_{CNTL} (indicated by arrow 242), RF IN 250, V_{CC} (indicated by arrow 254) and RF OUT 256 in Figure 2. Power control/current detection circuit 408 includes operational amplifiers (op amp) 460, 462, and 464, feedback network 466, transistors 468, 470, and 472, and resistor 478. Transistors 468 and 470 can each be, for example, a p-channel field-effect transistor (PFET). Transistor 472 can be, for example, an n-channel FET (NFET).

As shown in Figure 4, power control/current detection circuit 408 is coupled to power amplifier 406 by inductor 490, which can be, for example, an RF choke. Inductor 490 can prevent an RF signal in power amplifier 406 from entering power control/current detection circuit 408. Also shown in Figure 4, V_{CNTL} 442 is coupled to the negative terminal of op amp 460, feedback network 466 is coupled between the positive terminal of op amp 460 and the drain of transistor 468, the negative terminal of op amp 462 and a first terminal of inductor 490 at node 484, and a second terminal of inductor 490 is coupled to a supply voltage input of power amplifier 406. Node 484 has a voltage referred to herein as " V_{CC} " (indicated by arrow 454). Feedback network 466 can determine the gain of the linear regulator formed by op amp 460, feedback network 466, and transistor 468 and can be, for example, a resistive feedback network.

Also shown in Figure 4, the output of op amp 460 is coupled to the gates of transistors 468 and 470 and the sources of transistors 468 and 470 are coupled to power source 480, which can be a DC power source, such as a battery. Further shown in Figure 4, the positive terminal of op amp 462 is coupled to the drains of transistors 470 and 472, the output of op amp 462 is coupled to the gate of transistor 472, and the source of transistor 472 is coupled to the positive terminal of op amp 464 and a first terminal of resistor 478 at node 482. Also shown in Figure 4, the second terminal of resistor 478 is coupled to ground 488 and the negative terminal of op amp 464 is coupled to the output of op amp 464 at node 492, which provides V_{ICC} 430.

The function and operation of power control/current detection circuit 408 will now be discussed. Op amp 460, feedback network 466 and transistor 468 form a linear regulator that receives V_{CNTL} 442 and provides a supply voltage, i.e., V_{CC} , for power amplifier 406 at node 484. Power amplifier 406 draws I_{CC} (indicated by arrow 5 434), which is a supply current provided by power control/current detection circuit 408. I_{CC} , which is drawn from power source 480, is a large current that flows through transistor 468. The product of V_{CC} and I_{CC} determines the DC power provided to power amplifier 406. The current mirror formed by transistors 468 and 470, which are driven by op amp 460, provides a sense current (I_{SENSE}) (indicated by arrow 486), 10 which flows through transistors 470 and 472. I_{SENSE} is substantially equal to I_{CC} / N , where “N” is a mirror ratio and is determined by the size of transistor 468 with respect to the size of transistor 470.

Op amp 462 is utilized to cause the voltage drop across transistor 470 to be substantially equal to the voltage drop across transistor 468. In op amp 462, the 15 voltage at the positive terminal, which is coupled to the drains of transistors 470 and 472, is constrained to be substantially equal to the voltage, i.e., V_{CC} , at the negative terminal of the op amp. Thus, op amp 462 forms a feedback loop to increase the accuracy of the current mirror formed by transistors 468 and 470. I_{SENSE} flows through resistor 478 to ground 488, thereby causing V_{ICC} to be formed at node 482. As a result 20 of the current mirror formed by transistors 468 and 470, V_{ICC} is proportional to I_{CC} , i.e., the collector current drawn by power amplifier 406. Op amp 464 is configured to operate as a unity gain buffer to provide a high impedance load on node 482 so as to prevent current from being drawn from node 482 and, thereby, altering the relationship between V_{ICC} and I_{CC} . The negative terminal of op amp 464 is coupled to the output of 25 op amp 464, thereby providing V_{ICC} 430 at node 492.

A change in a load impedance of a load, such as load 203 in Figure 2, coupled to the output of power amplifier 406 can cause a corresponding change in I_{CC} , which is the supply current drawn by power amplifier 406. A change in I_{CC} can cause a corresponding change in V_{ICC} 430, which is proportional to I_{CC} . In the present 30 embodiment, V_{ICC} 430 forms a feedback voltage that can be utilized to sample I_{CC} . By

utilizing a feedback loop including power correction module 224, multiplication element 214, and predistortion module 216 in baseband module 202 in Figure 2, V_{CNTL} 442 can be adjusted to compensate for the change in I_{CC} caused by a change in load impedance. Since V_{CNTL} 442 determines V_{CC} , the present invention can cause an appropriate change in V_{CC} so as to advantageously provide a substantially constant power at the output of power amplifier 406 under load impedance variations.

Thus, by utilizing a power correction module in a feedback loop to sample collector current drawn by a power amplifier, the present invention provides power amplifier output power correction under variations in load impedance. As a result, the present invention can advantageously provide a substantially constant power amplifier output power under load impedance variations. Additionally, the present invention can provide a substantially constant output power while advantageously performing predistortion, which is required in transmitter systems using a modulation such as open-loop polar EDGE modulation.

From the above description of the invention it is manifest that various techniques can be used for implementing the concepts of the present invention without departing from its scope. Moreover, while the invention has been described with specific reference to certain embodiments, a person of ordinary skill in the art would appreciate that changes can be made in form and detail without departing from the spirit and the scope of the invention. Thus, the described embodiments are to be considered in all respects as illustrative and not restrictive. It should also be understood that the invention is not limited to the particular embodiments described herein but is capable of many rearrangements, modifications, and substitutions without departing from the scope of the invention.

Thus, an output power correction module for amplifiers in transmitters has been described.

CLAIMS

1. A transmitter system comprising:

a power amplifier receiving a supply voltage and a supply current from a power control/current detection circuit, said power amplifier driving a load impedance;

5 a power correction module configured to sample said supply current and to cause a change in a control voltage;

wherein said control voltage corrects said supply voltage in response to a change in said load impedance.

10 2. The transmitter system of claim 1, wherein said supply voltage is corrected so as to cause said power amplifier to have a substantially constant output power.

3. The transmitter system of claim 1, wherein said power correction
15 module is further configured to output a corrected peak voltage determined by an average value of said supply current.

4. The transmitter system of claim 3 further comprising a predistortion module configured to determine said control voltage from a product of said corrected
20 peak voltage and an amplitude modulation component and to output said control voltage to said power control/current detection circuit.

5. The transmitter system of claim 4 further comprising a phase modulator configured to receive a predistorted phase modulation component from said
25 predistortion module and to provide a phase modulated RF input signal to said power amplifier.

6. The transmitter system of claim 4 further comprising a multiplication element configured to receive said corrected peak voltage and said amplitude
30 modulation component and to output said product of said corrected peak voltage and

said amplitude modulation component.

7. The transmitter system of claim 1, wherein said power correction module receives a feedback voltage that is proportional to said supply current from
5 said power control/current detection circuit.

8. The transmitter system of claim 7, wherein said power correction module comprises a correction factor block configured to receive an average value of said supply current and to provide a correction factor for causing said change in said
10 control voltage in response to said change in said load impedance.

9. The transmitter system of claim 1, wherein said power amplifier generates a phase and amplitude modulated RF output signal.

15 10. The transmitter system of claim 8, wherein said transmitter system utilizes predistorted polar EDGE modulation.

11. The transmitter system of claim 7, wherein said power control/current detection circuit comprises a first and a second transistor configured as a current
20 mirror for providing a sense current, wherein said sense current causes said feedback voltage to be substantially proportional to said supply current.

12. The transmitter system of claim 11, wherein said power control/current detection circuit further comprises an operational amplifier having a negative input
25 coupled to a drain of said first transistor and a positive input coupled to a drain of said second transistor, wherein said operational amplifier forms a feedback loop to increase accuracy of said current mirror.

13. A power correction module for use with an amplifier driving a load
30 impedance, said power correction module comprising:

an integrator configured to generate an average value of a supply current of said amplifier in response to changes in said load impedance;

a correction factor block configured to receive said average value of said supply current and to provide a correction factor;

5 wherein said correction factor is utilized to correct a supply voltage of said amplifier.

14. The power correction module of claim 13, wherein said supply voltage is corrected so as to cause said amplifier to have a substantially constant output power.

10

15. The power correction module of claim 13 further comprising a multiplication element configured to receive said correction factor and a peak voltage and to provide a corrected peak voltage.

15 16. The power correction module of claim 15 wherein said corrected peak voltage is utilized to correct said supply voltage of said amplifier.

17. The power correction module of claim 13 further comprising a look-up table configured to receive a peak voltage and to determine an ideal value of said
20 supply current.

18. The power correction module of claim 17, wherein said correction factor is substantially equal to a square root of a ratio of said ideal value of said supply current over said average value of said supply current.

25

19. The power correction module of claim 13, wherein said integrator utilizes a feedback voltage that is proportional to said supply current and to generate said average value of said supply current.

30 20. The power correction module of claim 13, wherein said correction factor

is utilized to determine a control voltage, wherein said control voltage is utilized to correct said supply voltage of said amplifier.

21. The power correction module of claim 20, wherein said amplifier is
5 utilized as a power amplifier in a transmitter system.

22. The power correction module of claim 13, wherein said transmitter system utilizes polar EDGE modulation.

Fig. 1

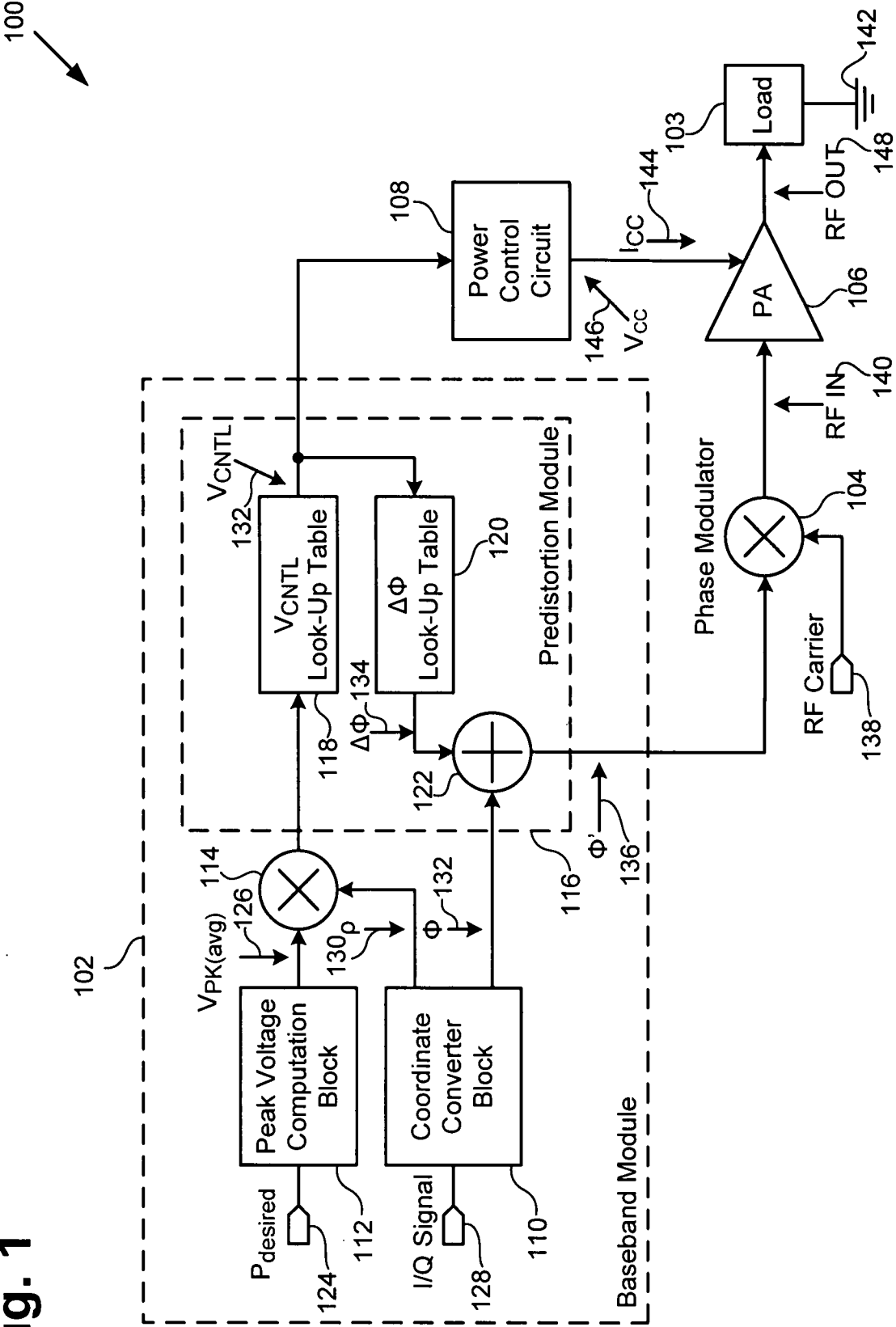


Fig. 2

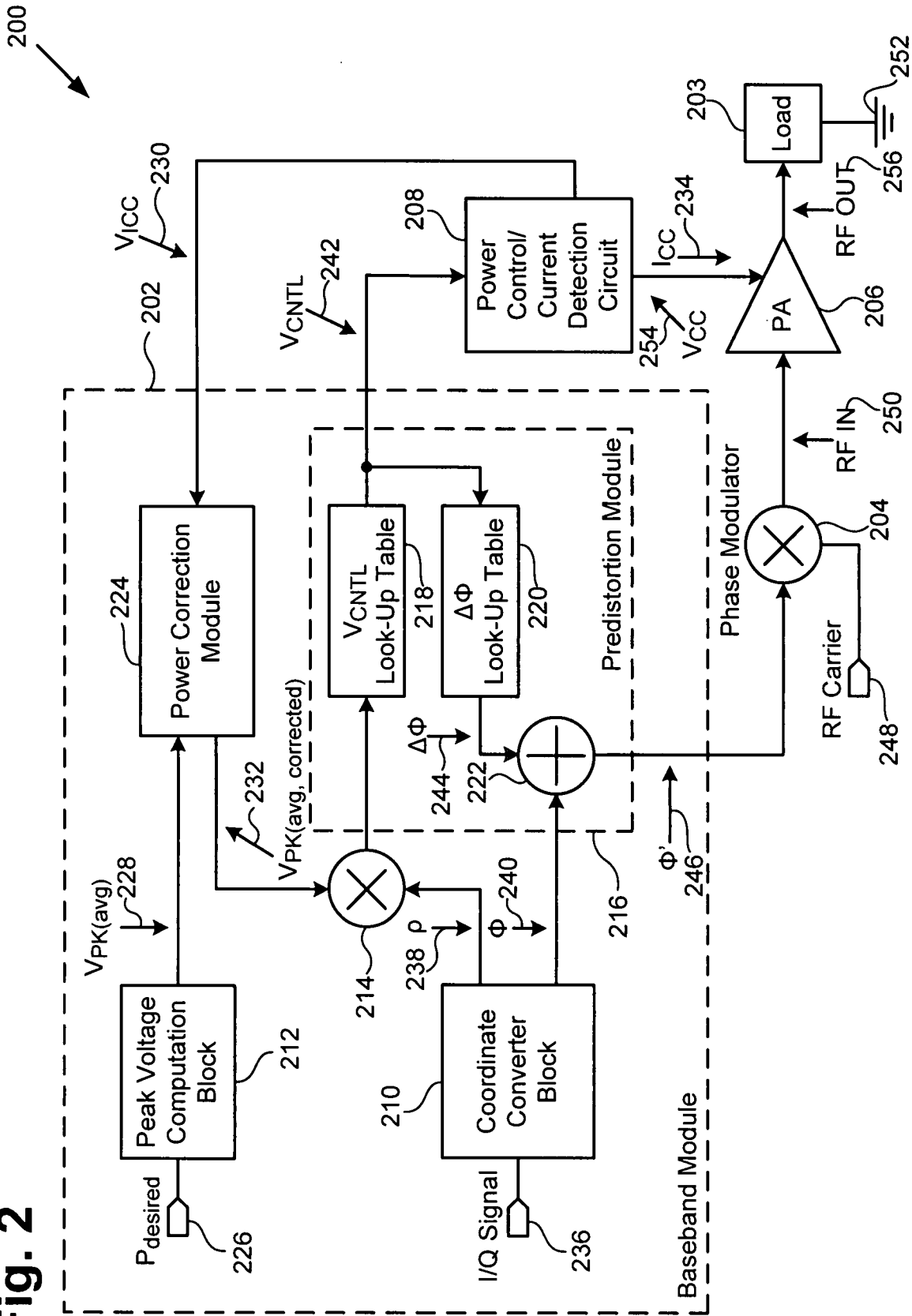


Fig. 3

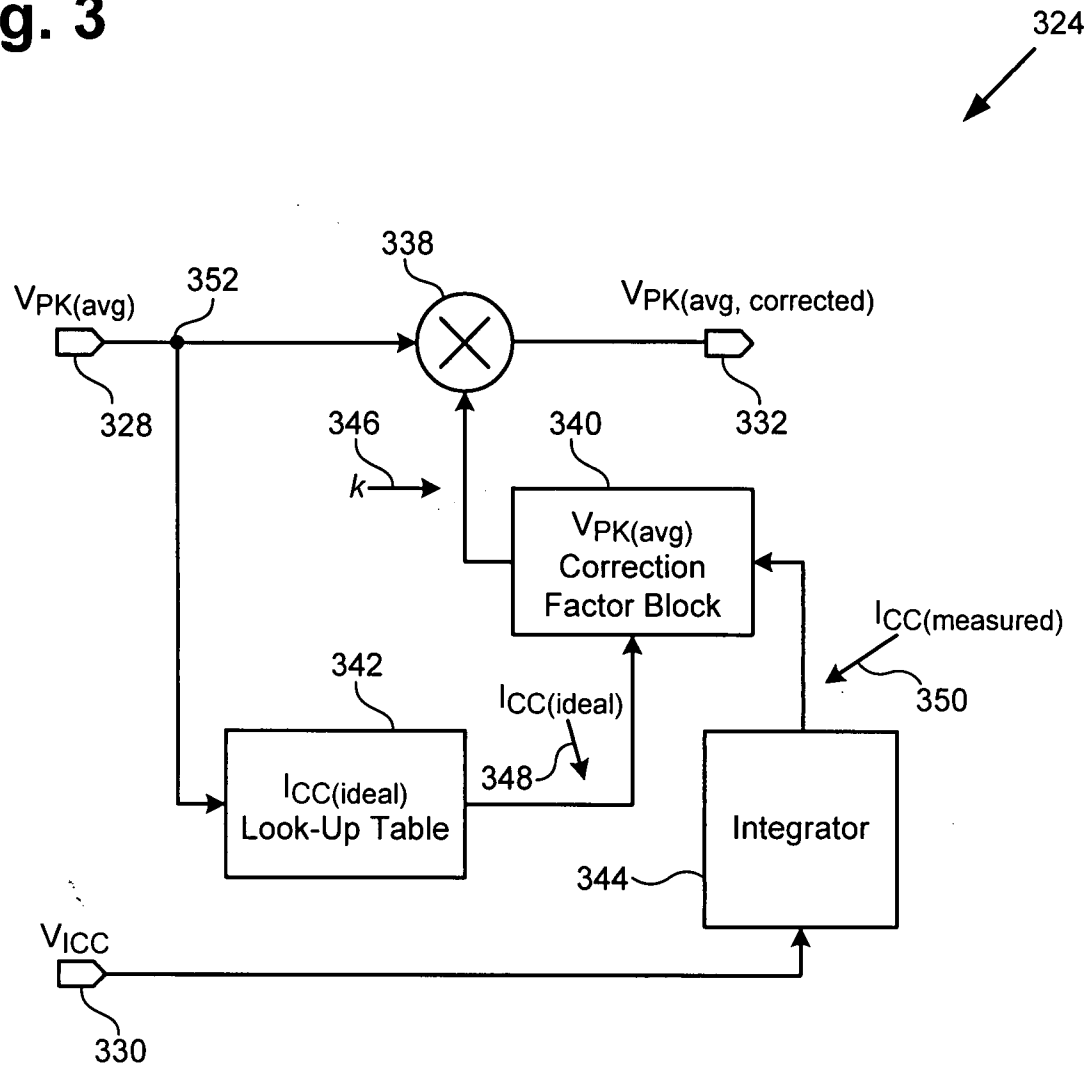


Fig. 4

